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(54) **ACTIVE DEVICE ARRAY SUBSTRATE**

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(57) **ABSTRACT**

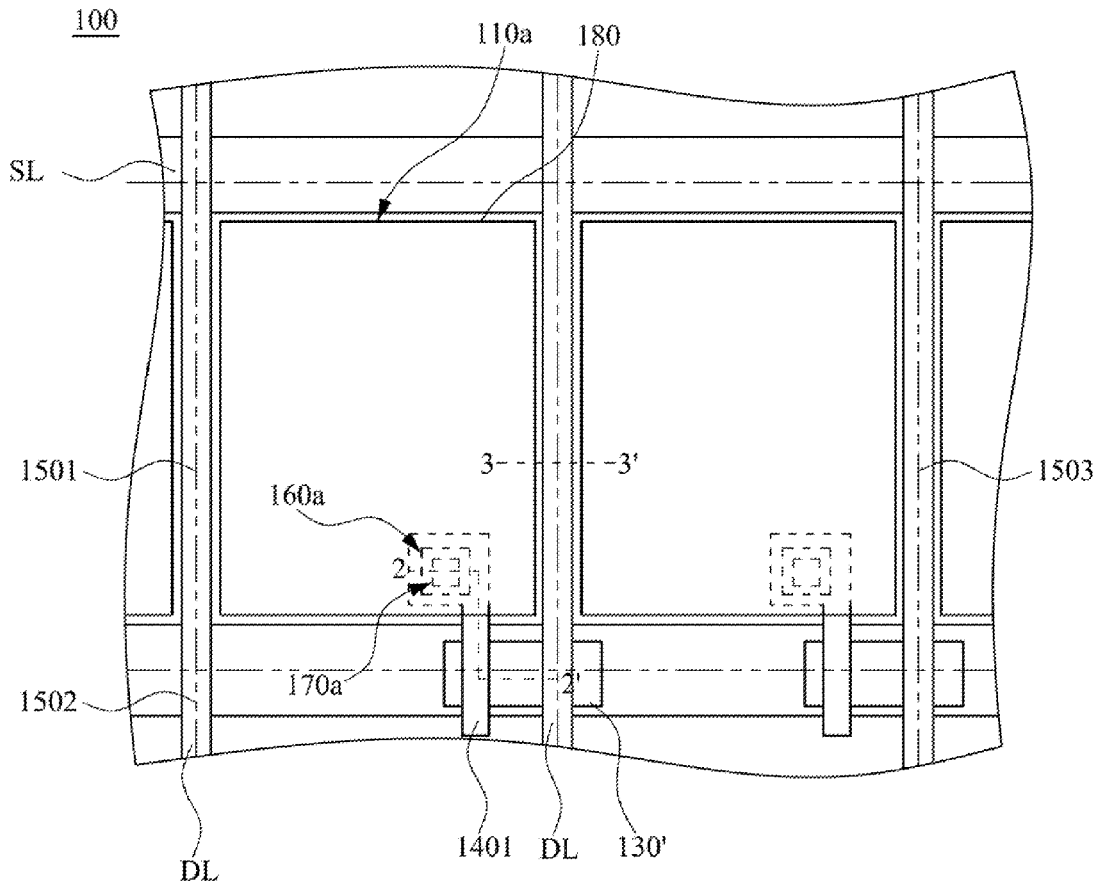
(21) Appl. No.: **13/974,073**

An active device array substrate for saving material cost includes a substrate, scan lines, data lines, a thin film transistor, a color filter layer, a transparent conductive layer, an insulating layer and a pixel electrode. The color filter layer covers and contacts the scan lines, data lines and the thin film transistor. The transparent conductive layer is disposed on the color filter layer and electrically isolated from the scan lines, the data lines and the thin film transistor by the color filter layer. The insulating layer covers the transparent conductive layer. The pixel electrode is disposed on the insulating layer and connected to the thin film transistor.

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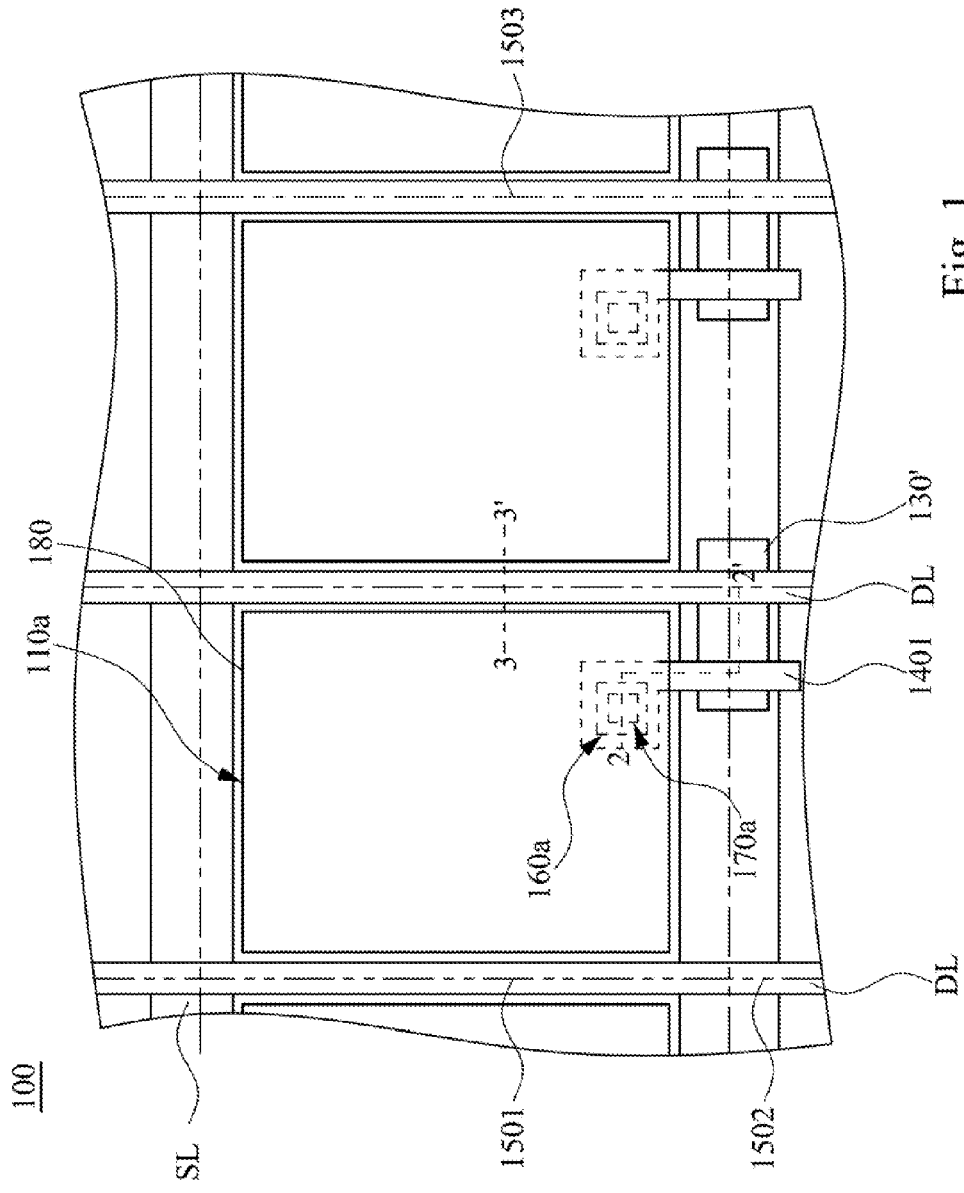


Fig. 1

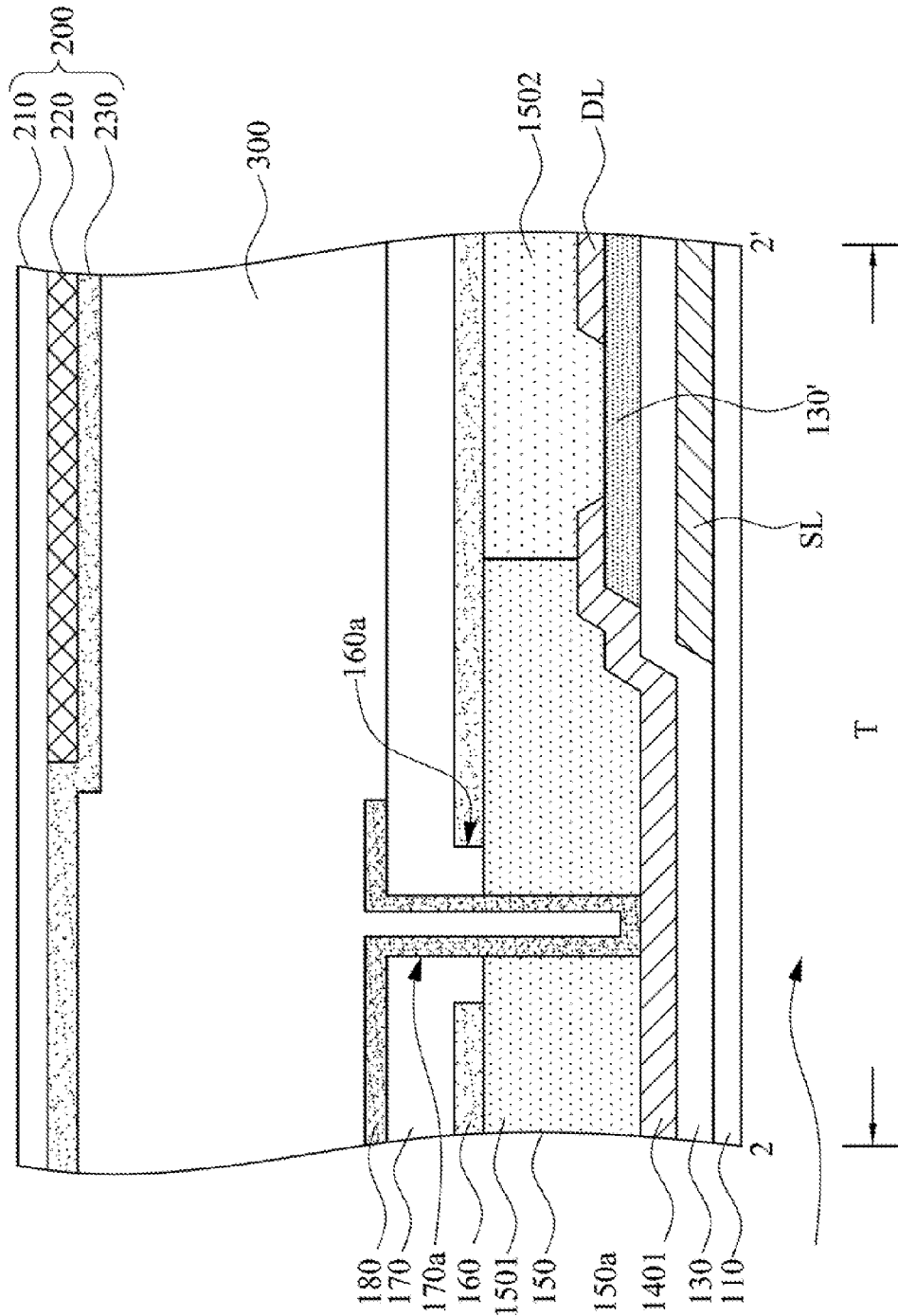


Fig. 2A

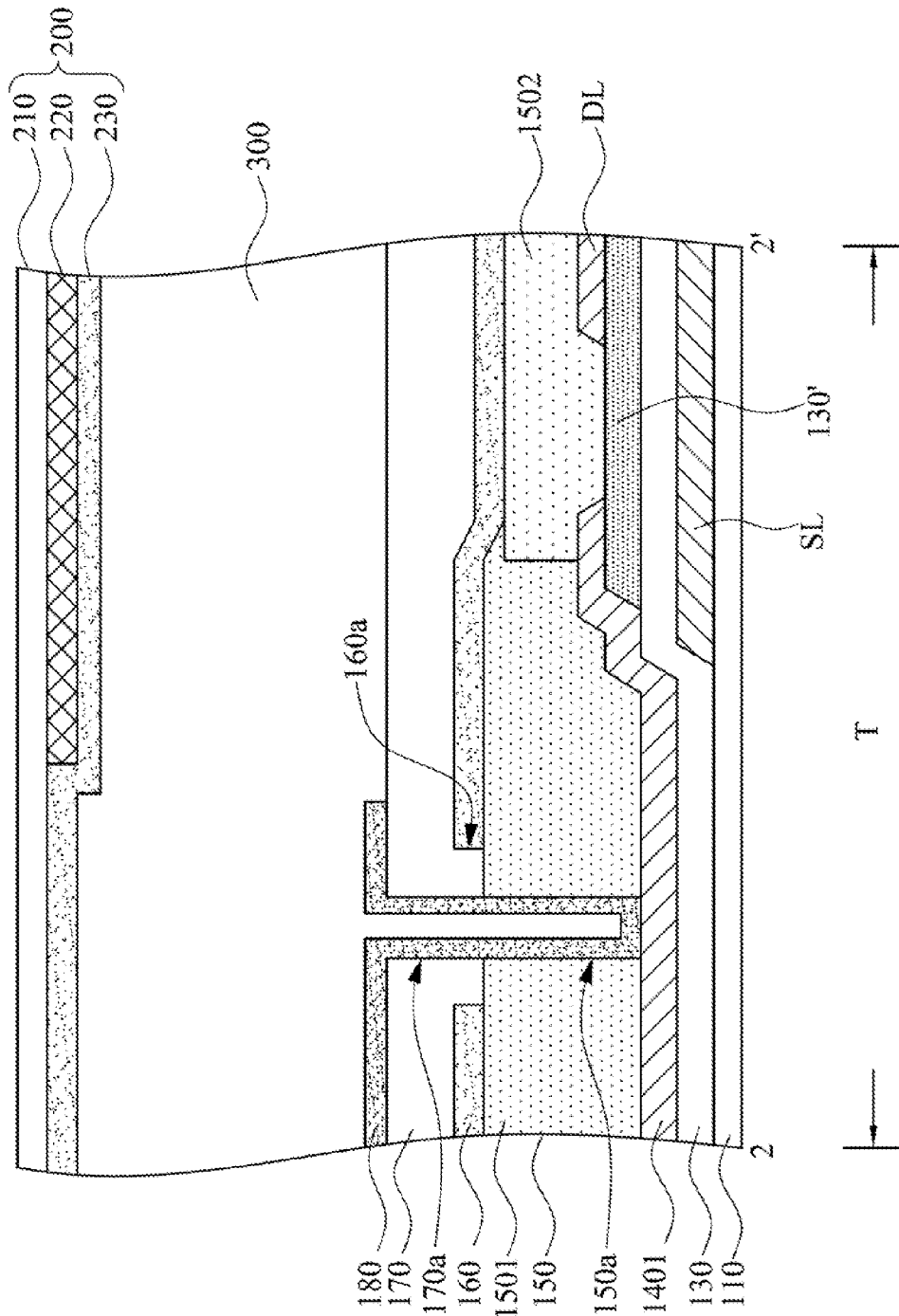


Fig. 2B

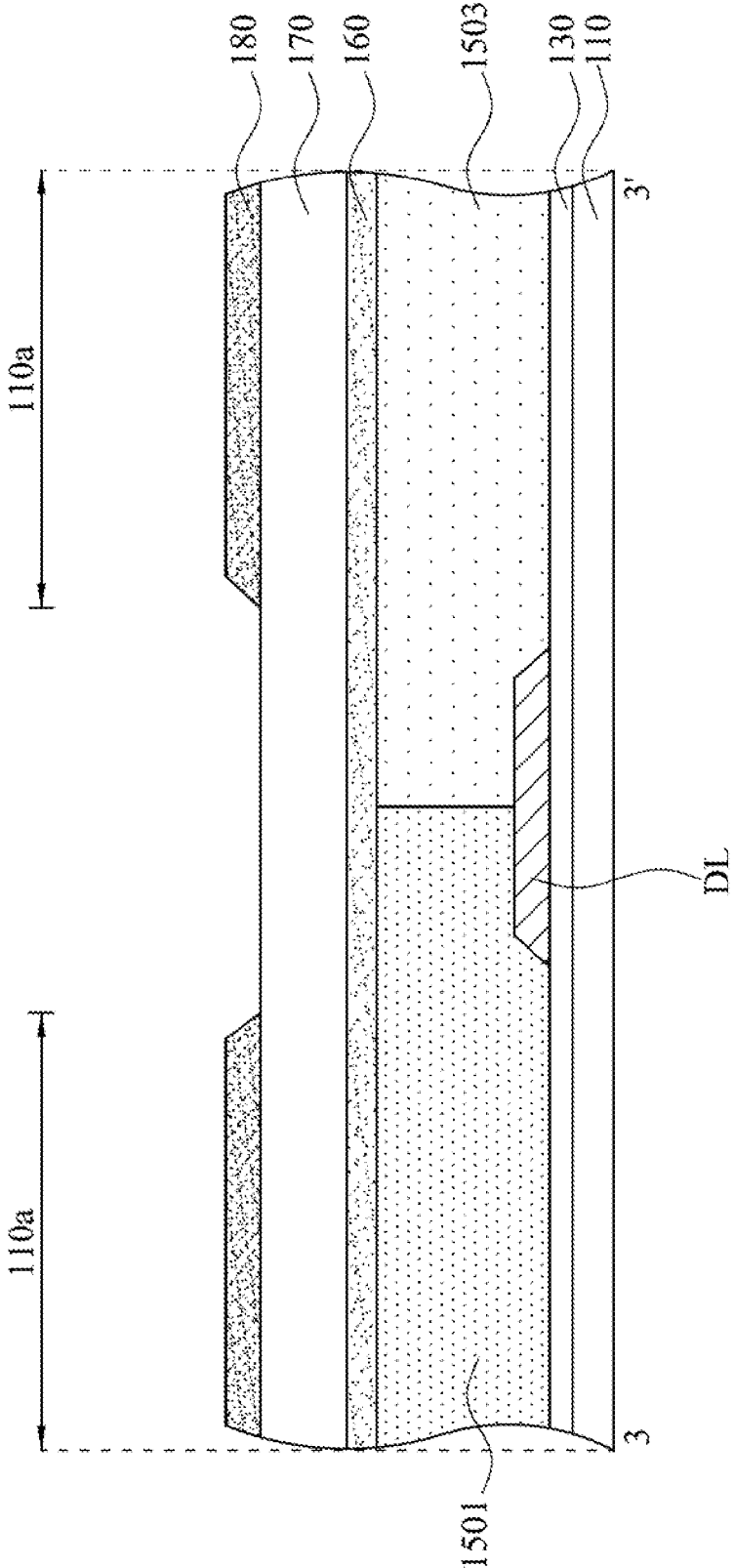


Fig. 3

ACTIVE DEVICE ARRAY SUBSTRATE

RELATED APPLICATIONS

[0001] This application claims priority to China Application Serial Number 201310072309.7, filed Mar. 7, 2013, which is herein incorporated by reference.

BACKGROUND

[0002] 1. Technical Field

[0003] The present disclosure relates to an active device array substrate.

[0004] 2. Description of Related Art

[0005] A liquid crystal panel has been widely applied as a display because the liquid crystal panel has advantages of compact size, lightweight, thin thickness and low power consumption compared to a cathode ray tube (CRT) monitor. Therefore, the flat display panel such as the liquid crystal display has completely taken over the traditional CRT monitor in recent years becoming the mainstream products in the market.

[0006] The liquid crystal display panel mainly includes an active device array substrate, a color filter substrate and a liquid crystal layer interposed therebetween. In general, the active device array substrate is made from a number of metal layers and a number of insulating layers by photolithography and etching processes. In other words, the materials and the processing steps respectively have certain costs. Therefore, how to save the cost of material for the active device array substrate has always been an important issue to be solved.

SUMMARY

[0007] One object of the present disclosure provides an active device array substrate having a high aperture ratio and capable of saving material cost.

[0008] One aspect of the present disclosure provides an active device array substrate including a substrate, scan lines, data lines, at least one thin film transistor, a color filter layer, a transparent conductive layer, an insulating layer and at least one pixel electrode. The scan lines are disposed on the substrate. The data lines are disposed on the substrate, and the data lines and the scan lines intersect with each other to define sub-pixel areas of the substrate. The thin film transistor is electrically connected to one of the scan lines and one of the data lines. The color filter layer covers and contacts the scan lines, the data lines and the thin film transistor. The transparent conductive layer is disposed on the color filter layer and electrically isolated from the scan lines, the data lines and the thin film transistor by the color filter layer. The insulating layer covers the transparent conductive layer. The pixel electrode is disposed on the insulating layer and covers one of the sub-pixel areas, and the pixel electrode is connected to the thin film transistor.

[0009] According to one embodiment of the present disclosure, the color filter layer includes color filter patterns adjacent and contacting each other.

[0010] According to one embodiment of the present disclosure, at least two of the color filter patterns are partially overlapped with each other.

[0011] According to one embodiment of the present disclosure, the transparent conductive layer provides a common voltage potential.

[0012] According to one embodiment of the present disclosure, the transparent conductive layer covers and contacts the color filter layer.

[0013] According to one embodiment of the present disclosure, the transparent conductive layer covers the sub-pixel areas of the substrate and the data lines.

[0014] According to one embodiment of the present disclosure, the transparent conductive layer further covers the scan lines and the thin film transistor.

[0015] According to one embodiment of the present disclosure, the color filter layer has a first through hole exposing a portion of the thin film transistor.

[0016] According to one embodiment of the present disclosure, the insulating layer has a second through hole disposed on the first through hole exposing the portion of the thin film transistor.

[0017] According to one embodiment of the present disclosure, the pixel electrode is connected to the thin film transistor through the first through hole and the second through hole.

BRIEF DESCRIPTION OF THE DRAWINGS

[0018] The disclosure may be more fully understood by reading the following detailed description of the embodiment, with reference made to the accompanying drawings as follows:

[0019] FIG. 1 is a top view of an active device array substrate according to one embodiment of the present disclosure;

[0020] FIGS. 2A-2B are cross-sectional views of the active device array substrate taken along the line 2-2 of FIG. 1; and

[0021] FIG. 3 is a cross-sectional view of the active device array substrate taken along the line 3-3' of FIG. 1.

DETAILED DESCRIPTION

[0022] The present disclosure is described by the following specific embodiments. Those with ordinary skill in the arts can readily understand the other advantages and functions of the present invention after reading the disclosure of this specification. The present disclosure can also be implemented with different embodiments. Various details described in this specification can be modified based on different viewpoints and applications without departing from the scope of the present disclosure.

[0023] As used herein, the singular forms "an" and the include plural referents unless the context clearly dictates otherwise. Therefore, reference to, for example, a thin film transistor includes aspects having two or more such thin film transistors, unless the context clearly indicates otherwise.

[0024] Reference will now be made in detail to the embodiments of the present disclosure, examples of which are illustrated in the accompanying drawings. Wherever possible, the same reference numbers are used in the drawings and the description to refer to the same or like parts.

[0025] FIG. 1 is a top view of an active device array substrate 100 according to one embodiment of the present disclosure. FIGS. 2A-2B are cross-sectional views of the active device array substrate 100 taken along the line 2-2' of FIG. 1. The embodiments shown in FIG. 2A and FIG. 2B are various embodiments.

[0026] Referring to FIG. 1 and FIG. 2A, the active device array substrate 100 includes a substrate 110, scan lines SL, data lines DL, a thin film transistor T, a color filter layer 150, a transparent conductive layer 160, an insulating layer 170 and a pixel electrode 180.

[0027] The substrate **110** should have a high light transmittance and sufficient mechanical strength, such as glass, quartz, transparent polymeric materials or other suitable materials.

[0028] The scan lines SL parallel to each other are disposed on the substrate **110**, as shown in FIG. 1. Of course, common lines (not shown) may be disposed on the substrate **110**. The common lines (not shown) may be parallel to an extending direction of scan lines SL.

[0029] The data lines DL parallel to each other are disposed on the substrate **110**, and the data lines DL and the scan lines SL intersect with each other so as to define sub-pixel areas **110a** of the substrate **110**. The scan lines SL and the data lines DL may be made of a material including a metal, such as molybdenum (Mo), chromium (Cr), aluminum (Al), neodymium (Nd), titanium (Ti), other suitable materials or a combination thereof.

[0030] The thin film transistor T corresponds to one of the sub-pixel areas **110a** and is disposed on the substrate **110**. The thin film transistor T is electrically connected to one of the scan lines SL and one of the data lines DL. Of course, a number of thin film transistors T may be respectively disposed on the sub-pixel regions **110a** of the substrate **110**. In the embodiment, a portion of the scan line SL is acted as a gate electrode, and a portion of the data line DL is acted as a source electrode, as shown in FIGS. 1 and 2A. That is, the thin film transistor T includes the gate electrode (i.e., the portion of the scan line SL), the source electrode (i.e., the portion of the data line DL), a drain electrode **1401** and an active layer **130'**. Further, a gate dielectric layer **130** is interposed between the active layer **130'** and the gate electrode (i.e., the portion of the scan line SL), as shown in FIG. 2A. Of course, the skilled in the art should understand that the thin film transistor T might be a bottom-gate type (as shown in FIG. 1) or a top-gate type (not shown) thin film transistor. Therefore, the layout can be appropriately altered and not limited to the embodiment shown in FIG. 1.

[0031] The gate dielectric layer **130** covers the scan lines SL, as shown in FIG. 2A. The gate dielectric layer **130** may be made of a material including an organic dielectric material, an inorganic dielectric material or a combination thereof. The organic dielectric material may be polyimide (PI), derivatives thereof, other suitable materials or a combination thereof. The inorganic material may be silicon oxide, silicon nitride, other suitable materials or a combination thereof. In one embodiment, the gate dielectric layer **130** blanket covers the sub-pixel areas **110a** of the substrate **110** and the scan lines SL.

[0032] The active layer **130'** is disposed on the gate dielectric layer **130**, shown in FIGS. 1 and 2A. The active layer **130'** may be made of a material including amorphous silicon, polycrystalline silicon, monocrystalline silicon, an organic semiconductor, an oxide semiconductor, other suitable materials or a combination thereof. In practical applications, both the shape and the location of the active layer **130'** are not limited to the embodiment shown in FIG. 1.

[0033] The color filter layer **150** covers and contacts the scan lines SL, the data lines DL and the thin film transistor T, as shown in FIG. 2A. That is, the color filter layer **150** is utilized to protect the scan lines SL, the data lines DL and the thin film transistor T therebeneath.

[0034] In the embodiment, the color filter layer **150** includes a number of color filter patterns adjacent and contacting each other. Since light passing through the color filter

layer **150** should perform different colors, the junctions between the color filter patterns should be located on the opaque elements such as the scan lines SL or the data lines DL.

[0035] The color filter patterns may be made of color photoresists (e.g., red, green, blue or other color photoresists) or other suitable materials. As shown in FIGS. 1 and 2A, the color filter layer **150** includes color filter patterns **1501**, **1502**, **1503**, and each thereof corresponds to one of the sub-pixel areas **110a**. For instance, the color filter patterns on the sub-pixel areas **110a** are made from different color photoresists by photolithography and curing processes. The color filter patterns are adjacent and contacting each other to constitute the color filter layer **150** without any gap.

[0036] In another embodiment, two color filter patterns **1501**, **1502** are partially overlapped on the scan lines SL. As such, there is no gap between the color filter patterns **1501**, **1502**.

[0037] The transparent conductive layer **160** is disposed on the color filter layer **150** and electrically isolated from the scan lines SL, the data lines DL and the thin film transistor T by the color filter layer **150**. As shown in FIG. 2A, the transparent conductive layer **160** covers and contacts the color filter layer **150**. Because the color filter layer **150** is made of a dielectric material and there is no gap therein, it can be acted as a protective layer between the transparent conductive layer **160**, and the scan lines SL, the data lines DL and the thin film transistor T. Also, there is no need for disposing another protective layer to cover the thin film transistor T, the scan lines SL and the data lines DL, such that the material cost can be saved.

[0038] In one embodiment, the transparent conductive layer **160** provides a common voltage potential. That is, a common voltage is applied to the transparent conductive layer **160** to make it has the common voltage potential.

[0039] In one embodiment, the transparent conductive layer **160** covers the color filter patterns **1501**, **1503**, the sub-pixel area **110a** of the substrate therebeneath and the data line DL, as shown in FIG. 3. Therefore, the transparent conductive layer **160** shields the data lines DL to avoid the signal of a pixel electrode **180** being interfered therefrom. Hence, the problems of reverse domain and light leakage caused by a capacitive coupling effect between the data line DL and the pixel electrode **180** can be avoided.

[0040] In another embodiment, the transparent conductive layer **160** further covers the scan lines SL and the thin film transistor T, as shown in FIG. 2A. That is, the transparent conductive layer **160** blanket covers the color filter layer **150** (i.e., the transparent conductive layer **160** fully covers the sub-pixel areas **110a** of the substrate **110**, the data lines DL, the scan lines SL and the thin film transistor T) to fully shield the data lines DL, the scan lines SL and the thin film transistor T so as to avoid the signal of the pixel electrode **180** being interfered therefrom.

[0041] Moreover, an embodiment that the transparent conductive layer **160** covers the sub-pixel areas **110a** of the substrate **110** and the data lines DL but does not cover the scan lines SL has lower RC loading of the transparent conductive layer **160** than another embodiment that the transparent conductive layer **160** blanket covers the color filter layer **150**.

[0042] The insulating layer **170** covers the transparent conductive layer **160**, and the pixel electrode **180** corresponds to one sub-pixel area **110a** and is disposed on the insulating layer **170**, as shown in FIG. 2A. Of course, the pixel elec-

trodes **180** may respectively correspond to the sub-pixel areas **110a** and be disposed on the insulating layer **170**.

[0043] The pixel electrode **180** is connected to the thin film transistor **T**. For instance, as shown in FIG. 2A, the color filter layer **150** has a first through hole **150a** exposing a portion of the drain electrode **1401** of the thin film transistor **T**. The insulating layer **170** has a second through hole **170a** disposed on the first through hole **150a** exposing the portion of the drain electrode **1401**. Therefore, the pixel electrode **180** is connected to the drain electrode **1401** of the thin film transistor **T** through the first through hole **150a** and the second through hole **170a**.

[0044] The transparent conductive layer **160**, the insulating layer **170** and the pixel electrode **180** constitutes a large-size transparent capacitor, such that the active device array substrate of the present disclosure has a higher aperture ratio than a conventional active device array substrate with a metal capacitor. In one embodiment, the transparent conductive layer **160** has a slit pattern (i.e., there is no transparent conductive layer **160** in the slit) to adjust a capacitance of the capacitor. Further, as shown in FIG. 2A, the transparent conductive layer **160** has an opening **160a**, such that the pixel electrode **180** in the second through hole **170a** is isolated from the transparent conductive layer **160**.

[0045] The transparent conductive layer **160** and the pixel electrode **180** may be made of indium tin oxide (ITO), indium zinc oxide (IZO), indium gallium zinc oxide (IGZO) or other suitable transparent conductive materials. The material of the pixel electrode **180** may be the same as or different from that of the transparent conductive layer **160**.

[0046] The display panel includes not only the active device array substrate **100** but also an opposite substrate **200** and a display medium layer **300**, as shown in FIG. 2A. Each of the elements of the active device array substrate **100** may refer to the above description, and thus it is omitted herein.

[0047] The opposite substrate **200** is parallel to the active device array substrate **100**. In the embodiment, the opposite substrate **200** includes an opposite plate **210** and a light-shielding layer **220**. The light-shielding layer **220** corresponds to the scan lines **SL** and the data lines **DL** of the active device array substrate **100**. Since the active device array substrate **100** includes the color filter layer **150**, there is no need for disposing another color filter layer on the opposite plate **210**.

[0048] Concerning a twisted nematic liquid crystal display (TN-LCD), the opposite substrate **200** further includes an opposite transparent electrode **230** covering the light-shielding layer **220** and the opposite plate **210**, as shown in FIG. 2A. A voltage between the opposite transparent electrode **230** and the pixel electrode **180** can be utilized to control the twist angle of the liquid crystal molecules so as to control the degree of light penetration.

[0049] Concerning an in-plane switching liquid crystal display (IPS-LCD), there is no need for disposing an opposite transparent electrode in the opposite substrate **200**, but a number of strip-shaped pixel electrodes (not shown) and a common electrode (not shown) should be provided and disposed on the sub-pixel area **110a** of the substrate **110** of the active device array substrate **100**. A lateral electric field formed between the strip-shaped pixel electrodes and the common electrode can be utilized to control the twist angle of the liquid crystal molecules.

[0050] The display medium layer **300** is interposed between the active device array substrate **100** and the opposite

substrate **200**. The display medium layer **300** may be made of liquid crystal, an electro-wetting material, a self-luminous material or other suitable materials.

[0051] As can be seen from the above description, the color filter layer of the embodiments of the present disclosure is acted as a protective layer for protecting the wires and the thin film transistors therebeneath, such that the material cost can be saved. Further, the transparent conductive layer shields the wires and the thin film transistors so as to avoid light leakage caused by a capacitive coupling effect. The display panel has a high aperture ratio, since the transparent conductive layer, the insulating layer and the pixel electrodes constitutes a transparent capacitor. In summary, the present disclosure indeed provides an active device array substrate having a high aperture ratio and capable of effectively saving the material cost.

[0052] Although the present disclosure has been described in considerable detail with reference to certain embodiments thereof, other embodiments are possible. Therefore, the spirit and scope of the appended claims should not be limited to the description of the embodiments contained herein.

[0053] It will be apparent to those ordinarily skilled in the art that various modifications and variations may be made to the structure of the present disclosure without departing from the scope or spirit of the disclosure. In view of the foregoing, it is intended that the present disclosure cover modifications and variations thereof provided they fall within the scope of the following claims.

What is claimed is:

1. An active device array substrate, comprising:
 - a substrate;
 - a plurality of scan lines disposed on the substrate;
 - a plurality of data lines disposed on the substrate, wherein the data lines and the scan lines intersect with each other to define a plurality of sub-pixel areas of the substrate;
 - at least one thin film transistor electrically connected to one of the scan to lines and one of the data lines;
 - a color filter layer covering and contacting the scan lines, the data lines and the thin film transistor;
 - a transparent conductive layer disposed on the color filter layer and electrically isolated from the scan lines, the data lines and the thin film transistor by the color filter layer;
 - an insulating layer covering the transparent conductive layer; and
 - at least one pixel electrode disposed on the insulating layer and covering one of the sub-pixel areas, the pixel electrode being connected to the thin film transistor.
2. The active device array substrate of claim 1, wherein the color filter layer comprises a plurality of color filter patterns adjacent and contacting each other.
3. The active device array substrate of claim 2, wherein at least two of the color filter patterns are partially overlapped with each other.
4. The active device array substrate of claim 1, wherein the transparent conductive layer provides a common voltage potential.
5. The active device array substrate of claim 1, wherein the transparent conductive layer covers and contacts the color filter layer.
6. The active device array substrate of claim 1, wherein the transparent conductive layer covers the sub-pixel areas of the substrate and the data lines.

7. The active device array substrate of claim 6, wherein the transparent conductive layer further covers the scan lines and the thin film transistor.

8. The active device array substrate of claim 1, wherein the color filter layer has a first through hole exposing a portion of the thin film transistor.

9. The active device array substrate of claim 8, wherein the insulating layer has a second through hole disposed on the first through hole exposing the portion of the thin film transistor.

10. The active device array substrate of claim 9, wherein the pixel electrode is connected to the thin film transistor through the first through hole and the second through hole.

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